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## **Supporting Information**



**Figure S1.1d-SAXS** curve for skin layer of SIS-S representing cylindrical structure with reflections at  $1:\sqrt{3}:2:\sqrt{7}$ . (Note: the peaks at  $\sqrt{3}q^*$  and  $2q^*$  are close and cannot be clearly distinguished.)

The d-spacing can be calculated from  $d=2\pi/q^*$  as 27.1nm.



Figure S2. Summary of 2d-SAXS patterns for different layers of samples along the

neutral direction (ND), transverse direction (TD) and flow direction (FD).



**Figure S3.** 2d-SAXS profiles for samples at different positions along the neutral direction (ND), transverse direction (TD) and flow direction (FD).



**Figure S4.** 1d-SAXS profiles as a function of q-spacing of different samples at the transition layer.

As shown in figure S4, 1-d scattering curves for all samples are similar and show several peaks which indicates the existence of well-ordered structure as expected. Taking q\* as the position of first peak, three distinct reflections with positional ratios of q-spacing values appear at  $1:\sqrt{3}:2:\sqrt{7}$  relative to q\* in SIS-15D. This sequence of reflections generally indicates a hexagonally packed cylindrical structure emerges in SIS-15D. For detailed comparison, SIS-S shows spatial order to some extent but is lower than that of SIS-15D while dynamic packing injection molded sample with short cessation time (such as SIS-3D) owns weakened high-order reflections indicating a lack of packing order. In addition, SIS-6D gains a trend of order enhancement corresponding with  $2q^*$  and  $\sqrt{7}q^*$  as the shear cessation time prolongs. In addition, the key procedure in "dynamic packing injection moulding" lies in the shear on the solid/melt interface after injection flow. The mould temperature was set as 30°C so as to instantly solidify the structures experiencing shear history. As is reported in previous literature, the fast decay of modulus emerged at temperature T=90.7°C which is close to  $T_g$  of PS. The plateau holds about 10<sup>1</sup> seconds. In our experiment, shear process is coupling with the cooling processing. The temperature for dynamic-packing process lies between the melt temperature (200°C) and the mould temperature (30°C). So the time scale of the relaxation of SIS is enough in our experiment (3s, 6s, 15s).